



Semiconductor Equipment Association of Japan

3,Rokubancho
Chiyoda-ku,Tokyo,Japan
Web <https://www.seaj.or.jp>

August Billings (Express Report)

Japan-based Semiconductor Manufacturing Equipment

Note : All data is based on three month average numbers.

Mark your calendars. **The September Report SEAJ's Web site update** is scheduled on **19th October** approximately 3:40P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts August 2021 Billings of ¥245,719 million
Tokyo Japan, **September 16th, 2021** JAPAN-based manufacturers of semiconductor equipment posted **¥245,719 million** in billings in **August 2021** (three-month average basis) published today by SEAJ.

The billings figure is **2.1 percent up** the final July 2021 level of ¥240,743 million and **30.4 percent up** the August 2020 billings level of ¥ 188,407 million.

The SEAJ billings are three-month moving average billings for the Japanese semiconductor equipment industry. Billings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Month-Over-Month	Year-Over-Year
March 2021	240,696	28.4%	22.0%
April 2021	282,054	17.2%	35.5%
May 2021	305,405	8.3%	48.6%
June 2021	249,474	-18.3%	38.3%
July 2021(final)	240,743	-3.5%	28.1%
August 2021(prim)	245,719	2.1%	30.4%

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Billings published by SEAJ that tracks billings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings of the chips themselves.

SEMI is released North American Semiconductor Manufacturing Equipment Billings Report on Website.

<https://www.semi.org/en/MarketInfo/billings>

CONTACT : Akihide Kobayashi Secretary General & General Manager of Public Relations Department SEAJ
Web <https://www.seaj.or.jp> E-mail akobayashi@seaj.or.jp